

UM10758

TEA1836DB1094 TEA1836XT + TEA1792T 65 W notebook adapter

Rev. 1 — 4 December 2013

User manual

Document information

Info	Content
Keywords	TEA1836DB1094, TEA1836XT, very low standby power consumption, high peak power, active X-cap discharge, burst mode operation, flyback converter, 65 W, notebook adapter, controller, converter, power supply, demo board
Abstract TheTEA1836XT is a high-featured low-cost DCM/QR flyback of controller. It provides high efficiency at all power levels including no-load power consumption at nominal output voltage in burst operation.	
	To minimize the risk of audible noise, burst mode operation is included for the low load range. Switching in the audible frequency range is limited and peak currents are low.
	The TEA1836XT is intended for power supplies up to 75 W with extra high peak power capabilities to enable supplying high peak power equipment without requiring a PFC.
	This document describes the 65 W notebook adapter demo board with the TEA1836XT and TEA1792TS. The demo board provides an output of 19.5 V/3.34 A.
	The average efficiency is above 91 $\%$ and the no-load power consumption is below 30 mW.



TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

Revision history

Rev	Date	Description
v.1	20131204	first issue

Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

1. Introduction

WARNING

Lethal voltage and fire ignition hazard





The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire.

This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits. This product shall never be operated unattended.

1.1 Scope of this document

This document describes the 65 W notebook adapter TEA1836DB1094 demo board using the TEA18361T and TEA1792TS. It contains a set of measurements that shows the main characteristics.

1.2 TEA1836XT

The TEA1836XT is a controller IC for low-cost Switched Mode Power Supplies (SMPS) intended for flyback topologies. The built-in green functions provide high efficiency at all power levels.

At high power levels the flyback operates in QR mode. When lowering the power levels, the controller switches to DCM or Frequency Reduction (FR) mode. The peak current is reduced to 25 % of the maximum peak current.

At low power levels, when the flyback switching frequency reaches 25 kHz, the flyback converter switches to burst mode. To ensure high efficiency at low power and excellent no-load power performance, a burst mode has been integrated that reduces the optocurrent to a minimum level. As the switching frequency in this mode has a minimum value of 25 kHz while the burst frequency is always below 800 Hz, the frequencies are outside the audible range.

During the non-switching phase of the burst mode, the internal IC supply current is reduced to further optimize efficiency.

Valley switching is used in all operating modes.

The TEA1836XT includes an OverPower Protection (OPP). The OPP enables the controller to deliver 150 % peak power for a limited amount of time (200 ms) in case of overpower situations. If the output is shorted, the output power is limited to 100 % to keep the average power consumption lower than 5 W.

The TEA1836XT is realized in a high-voltage SOI (Silicon-On-Insulator) process. This process combines the advantages of a low-voltage process, like accuracy, high-speed protection functions, and control, while maintaining the high-voltage capabilities like high-voltage start-up and integrated X-cap discharge.

The TEA1836XT enables low-cost, highly efficient and reliable supplies for power requirements up to 75 W to be designed easily and with a minimum number of external components.

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

1.3 TEA1792TS

The TEA1792TS is a member of the generation of Synchronous Rectifier (SR) controller ICs for switched mode power supplies. Its high level of integration enables the design of a cost-effective power supply with a very low number of external components.

The TEA1792TS is a controller IC dedicated to synchronous rectification on the secondary side of discontinuous conduction mode and quasi-resonant flyback converters

1.4 Setup of the 65 W notebook adapter

The board is designed for universal mains (90 V (AC) to 264 V (AC)). When a DC input voltage is applied, the power consumption is higher due to continuous activation of the X-capacitor discharge function.

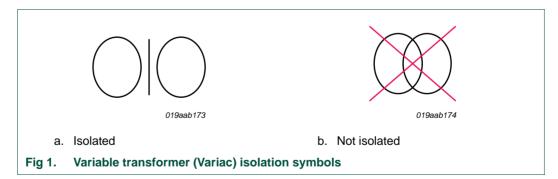
The demo board incorporates two subcircuits:

- A DCM/QR type flyback converter
- A Synchronous Rectifier (SR)

The purpose of the demo board is to show the operation of the TEA1836XT and TEA1792TS in a single output supply. The performance is according today's general standards including the DoE + CoC efficiency requirements. It can be used as a starting point for further product development.

2. Safety warning

The board must be connected to the mains voltage. Touching the board during operation must be avoided at all times. An isolated housing is obligatory when used in uncontrolled, non-laboratory environments. A galvanic isolation of the mains phase using a variable transformer is always recommended. Figure 1 shows the symbols by which these devices can be recognized.



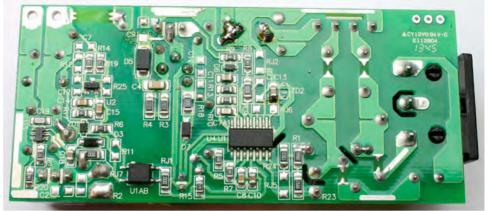
TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

3. Boa rd photographs



aaa-010346

a. Top



aaa-010347

b. Bottom

Fig 2. TEA1836XT and TEA1792TS demo board 65 W notebook adapter

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

4. S pecifications

Table 1. Input specification

Symbol	Description	Conditions	Value
V_{i}	input voltage		90 V to 264 V
f _i	input frequency		47 Hz to 64 Hz
P _{i(noload)}	no-load input power	at 230 V/50 Hz	< 30 mW

Table 2. Output sepcification

Symbol	Description	Condition	Value
V_{o}	output voltage		19.5 V
Io	output current		0 A to 3.33 A
I _{o(peak)}	peak output current	for 200 ms at $V_i = 90 \text{ V}$ at 60 Hz	5 A
t _{hold}	hold time	at 115 V/60 Hz; full load	> 10 ms
-	line regulation		±1 %
-	load regulation		±1 %
t _{startup}	start-up time	at 115 V/60 Hz	≤1 s
η	efficiency	DoE: > 88.5 % at cable end (including 0.5 % margin); CoC: > 89.5 % at cable end (including 0.5 % margin)	≥ 90 %
-	ElectroMagentic Interference (EMI)	CISPR22 compliant	pass

5. Measurement s

5.1 T est facilities

Oscilloscope: Yokogawa DL9140L
 AC Power Source: Agilent 6812B
 Electronic load: Agilent 6063B

• Digital power meter: Yokogawa WT210

5.2 Efficiency

Efficiency measurements are performed at stabilized conditions. The output voltage and output current is measured directly at the PCB connector. Measurements are done for 115 V/60 Hz and 230 V/50 Hz. Table 3 shows the average value of 10 boards.

Table 3. Efficiency results

Condition	ENERGY STAR 2.0 efficiency requirement (%)	Average	100 % load	75 % load	50 % load	25 % load
115 V/60 Hz	> 87	91.3	91.0	91.6	91.6	91.0
230 V/50 Hz	> 87	91.4	92.2	91.7	91.3	90.5

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

5.3 S tandby power consumption

Power consumption performance of the total application board without load connected was measured with a Yokogawa WT210 digital power meter. Integration time was set to 5 minutes to measure the average dissipated power.

Measurements were performed for 115 V/60 Hz, 230 V/50 Hz, and 264 V/50 Hz. $\underline{\text{Table 4}}$ shows the average value of 10 boards.

Table 4. Standby power consumption: No-load

Condition	ENERGY STAR 2.0 requirement (mW)	No-load power consumption (mW)
115 V/60 Hz	≤ 300	21
230 V/50 Hz	≤ 300	24
264 V/50 Hz	≤ 300	27

5.4 Current for changing between normal and burst mode operation

Table 5. Current for changing between normal and burst mode operation

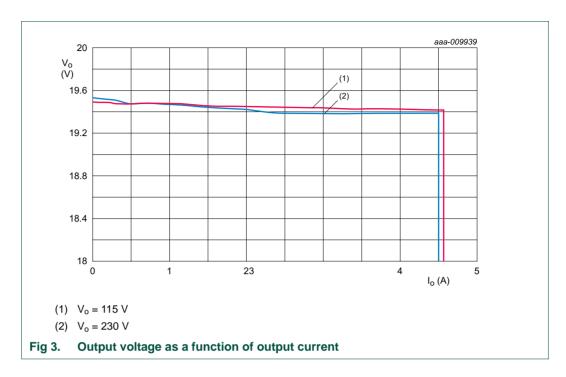
Condition	115 V/60 Hz	230 V/50 Hz
From normal mode	to burst mode operation	
current (A)	0.630	0.725
power (W)	12.3	14.1
From burst mode to	normal mode operation	
current (A)	0.425	0.460
power (W)	8.3	9.0

5.5 Load regulation

The output voltage versus load current was measured at the PCB connector.

User manual

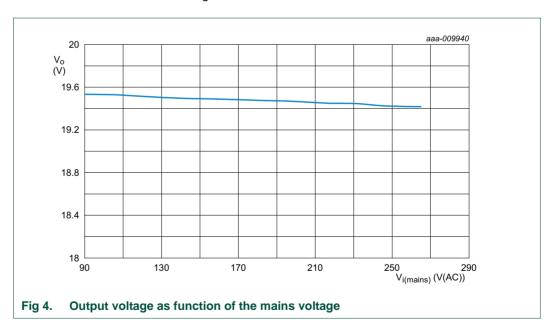
TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter



5.6 Line regulation

The output voltage versus mains input voltage was measured directly at the output connector for nominal load condition (3.34 A).

The values remain within the target of 19.5 V $\pm 1\%$.



5.7 Output voltage regulation in standby mode

The output voltage regulation during no load operation was measured for 90 V/60 Hz and 264V /50H z.

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

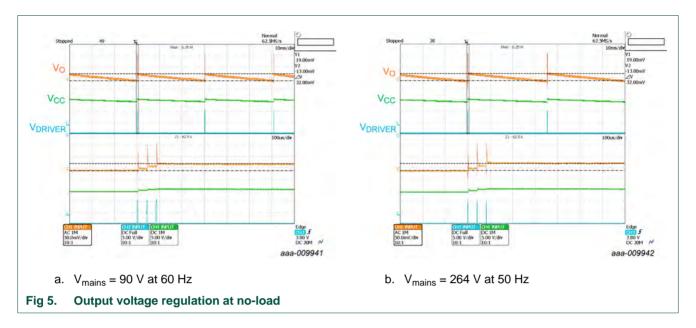
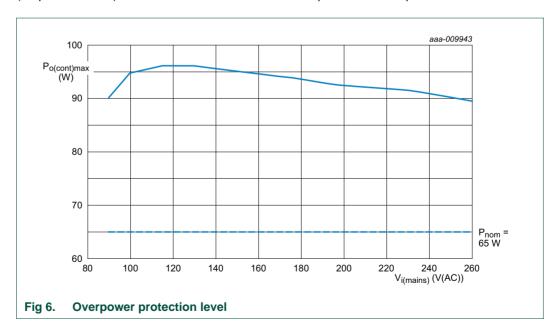


Table 6. Output voltage ripple at no-load condition

Symbol	90 V/60 Hz	230 V/50 Hz
V _{ripple} (mV)	32	32

5.8 OverPower Protection (OPP)

The continuous maximum peak output power was measured directly at the output connector for various mains input voltages. When this level is exceeded, the protection (stop and restart) is activated after the internal overpower counter passes 200 ms.



TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

5.9 Voltage on pin VCC

Table 7. VCC voltage

Condition	115 V/60 Hz	230 V/50 Hz
no-load	14.7	14.7
nominal load	18.3	16.8

5.10 Brownout and start-up level

Table 8. VCC voltage

Condition	Brownout (V)	Start level (V)
no-load	77	84
nominal load	77	84

5.11 Short circuit protection

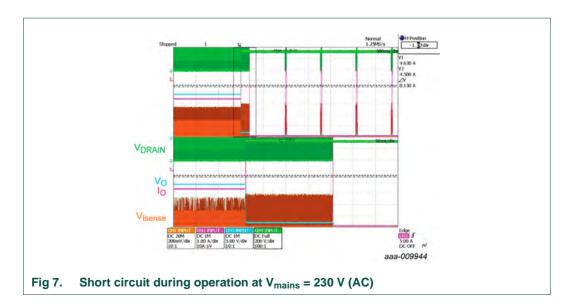
Output short circuit directly at the PCB connectors before switching on the mains voltage or during operation. The system protects and restarts continuously during the short circuit condition.

Table 9. Behavior during output short circuit condition

Condition	Behavior
output short before applying AC mains voltage	restart
output short circuit during operation at full load and no-load	restart

Table 10. Input power at output short circuit condition

Condition	90 V/60 Hz	230 V/50 Hz	264 V/50 Hz
input power	0.71 W	0.56 W	0.58 W



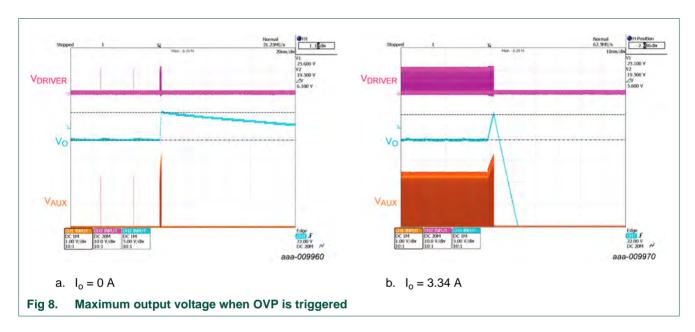
TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

5.12 Overvolt age protection

Applying a short circuit across the opto-LED of the optocoupler (U1B; see <u>Figure 20</u>) creates an output overvoltage condition. The overvoltage protection is triggered when the AUX pin voltage increases to 3 V during the OVP detection interval. The output voltage was measured directly at the output connector for both a nominal load (3.34 A) and a no-load condition.

Table 11. Maximum output voltage at OVP

Condition	115 V/60 Hz	230 V/50 Hz
no-load	25.6 V	25.6 V
nominal load (3.37 A)	25.1 V	25.1 V



5.13 S tart-up time

This is the time between the mains voltage switching on and the nominal output power available at the output.

Table 12. Start-up time

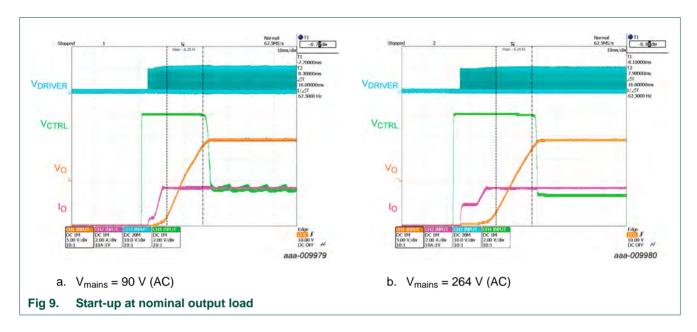
Condition	Start-up time
90 V/60 Hz	400 ms
115 V/60 Hz	300 ms
230 V/50 Hz	150 ms

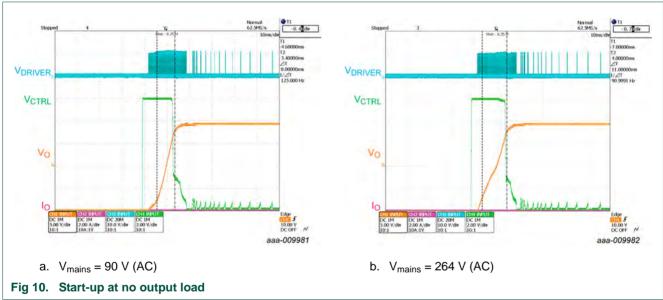
5.14 S tart-up profile

The shape of the output voltage during start-up was measured for 90 V/60 Hz and 264 V/50 Hz directly at the output connector for a no-load and a nominal load (3.34 A) condition.

User manual

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter





5.15 Hold-up time

The hold-up time is defined as the time between the following moments:

- After mains switch-off: The moment that the lowest bulk capacitor voltage during a mains cycle is crossed.
- The moment that the output voltage starts to decrease.

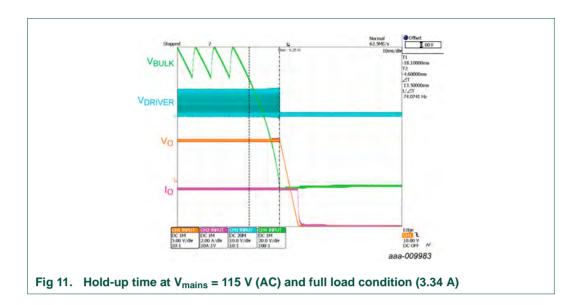
The hold-up time is measured for 115 V/60 Hz for a full load (3.34 A) condition. The output voltage was measured directly at the output connector.

Table 13. Hold-up time

Condition	Hold-up time
115 V/60 Hz	13.5 ms

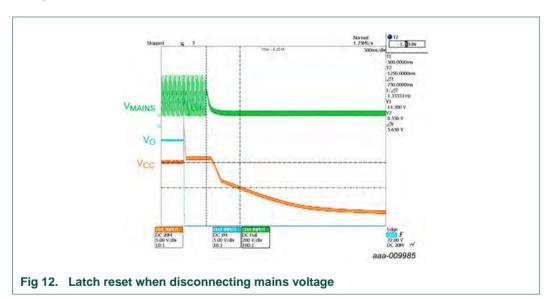
UM10758

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter



5.16 Fast latch reset

The fast latch reset time was measured. The fast latch reset time is the time that the voltage on pin VCC requires to drop to the reset level (8.65 V typical) when the mains voltage is disconnected. It is 750 ms.



5.17 X-capacitor discharge time

Unplug the power line at no-load condition and measure the discharge time at the X-capacitor (330 nF).

The discharge time is the time between the moment of disconnecting the mains source and the moment when the voltage reaches a defined voltage value.

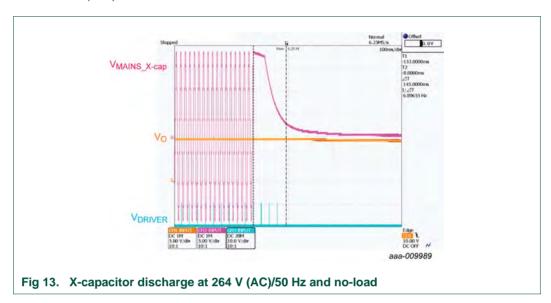
Table 14. X-capacitor discharge time test results

Condition	from 264 V * √2 to 135 V	from 264 V * √2 to 60 V
X-capacitor discharge time	55 ms	145 ms

UM10758

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

Remark: The discharge can start 100 ms later (worse case) than measured and shown because in burst mode operation the mains measurement interval is approximately 100 ms ($t_{wait(burst)HV}$).

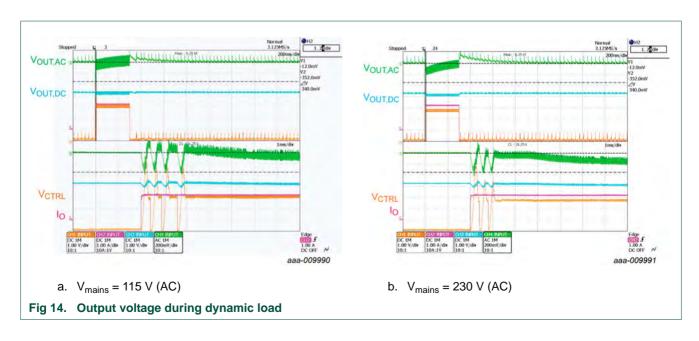


5.18 Dynamic load

The output voltage was measured at the end of the board.

Table 15. Maximum output voltage in case of OVP

Condition	Load	Output voltage ripple (mV)
115 V/60 Hz	I _o : 0 % to 100 %	340
230 V/50 Hz	I _o : 0 % to 100 %	340

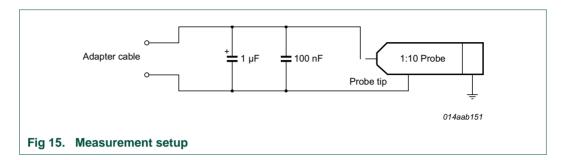


UM10758 NXP Semiconductors

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

5.19 Output ripple

Output ripple was measured at the end of the cable using a standard filter of 1 μ F + 100 nF on the probing position. Output ripple and noise was measured at nominal output current (3.34 A) and at no-load condition (0 A).



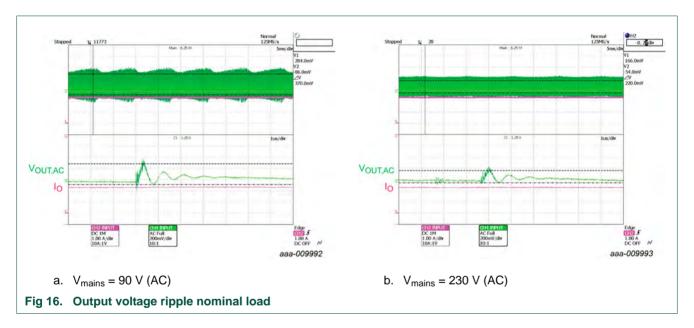


Table 16. Output voltage ripple at nominal load

Condition	peak-to-peak output voltage ripple and noise
90 V/60 Hz	370 mV
230 V/50 Hz	220 mV

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

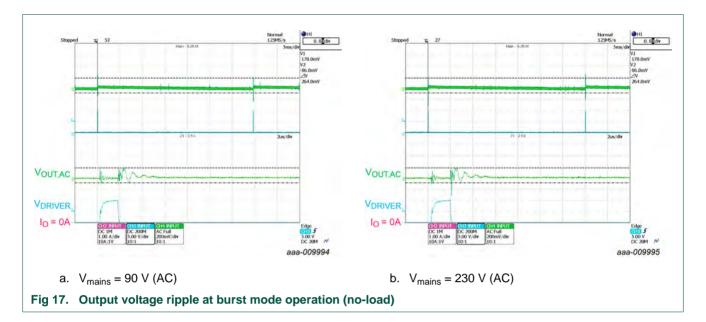


Table 17. Output voltage ripple at no-load

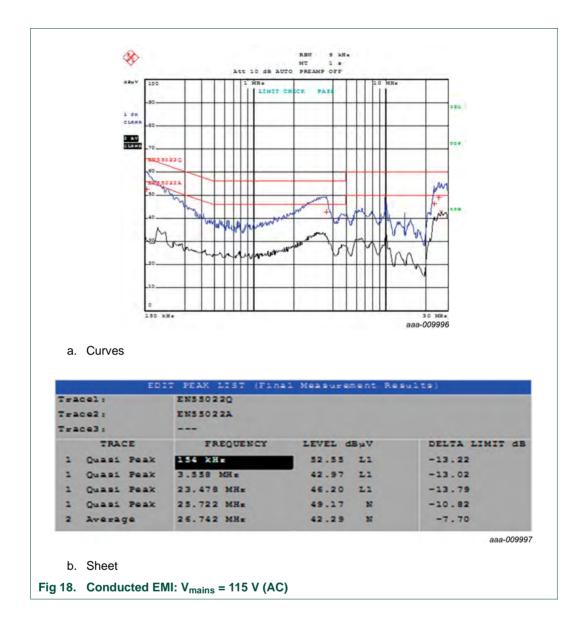
Condition	peak-to-peak output voltage ripple and noise
90 V/60 Hz	264 mV
230 V/50 Hz	264 mV

5.20 EMI performance

Conditions:

Type: Conducted EMI measurement
Frequency range: 150 kHz to 30 MHz
Output power: Full load condition
Supply voltage: 115 V and 230 V

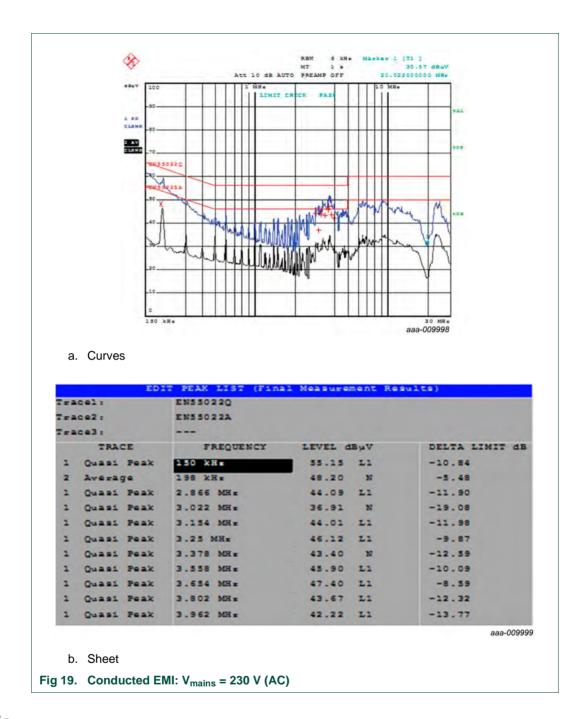
TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter



UM10758

UM10758 NXP Semiconductors

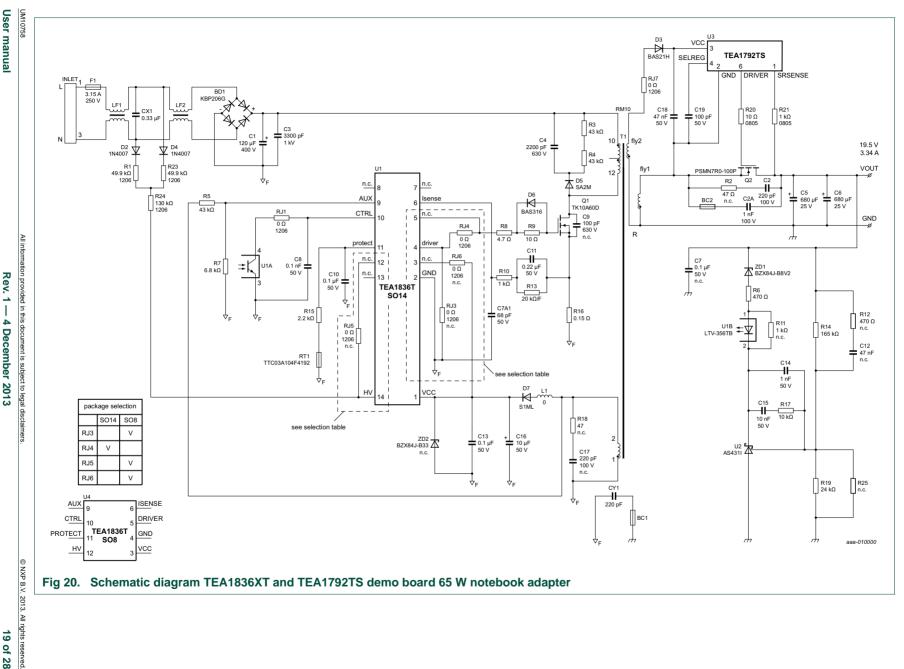
TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter



6. Schematic

Figure 20 shows a set of functional jumper positions that is present on the demo board. By mounting a configuration of jumpers, the demo board can be used for a SO8 or a SO14 package of the TEA1836XT. The table shows the jumpers that require to be mounted for the preferred package. The demo board is standard equipped with a SO14 package and configuration.



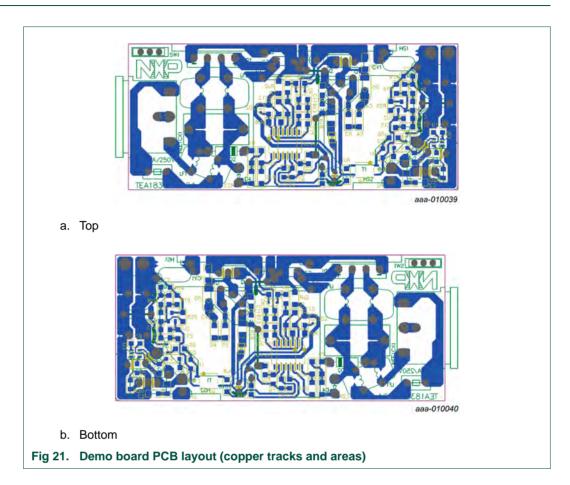


Rev. 1

UM10758 NXP Semiconductors

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

7. PCB layout



TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

8. Bill Of Material (BOM)

Table 18. TEA1836DB1094 bill of material

Reference	Description and values	Part number	Manufacturer
BC1; BC2	bead	-	-
BD1	bridge diode; flat/mini; 2 A; 600 V	2KBP206G	LiteOn
C1	capacitor; 120 μ F; 400 V; 105 °C; 18 mm × 30 mm;	-	KMG/NCC
C2	capacitor; not connected; 220 pF; 100 V; ±5 %; 0805; NPO; RoHS compliant	-	-
C2A	capacitor; leaded type; 1 nF; 100 V	-	-
C3	capacitor; DIP; 3300 pF; 1 kV	-	-
C4	capacitor; MLCC; 2200 pF; 630 V; 1206; Z5U		
C5; C6	capacitor; 680 μ F; 25 V; 105 °C; 10 mm \times 16 mm	-	KZH/NCC
C7	capacitor; MLCC; not connected; 0.1 $\mu\text{F};$ 50 V; ±10 %; 0805; X7R; RoHS compliant		
C7A1	capacitor; MLCC; 68 pF; 50 V; \pm 10 %; 0805; X7R; RoHS compliant		
C8	capacitor; MLCC; 1 nF; 50 V; \pm 10 %; 0805; X7R; lead free		
C9	capacitor; MLCC; not connected; 100 pF; 2 kV; 1206; Z5U		
C10	capacitor; MLCC; 0.1 $\mu\text{F};$ 50 V; ±10 %; 0805; X7R; RoHS compliant		
C11	capacitor; MLCC; 0.22 $\mu\text{F};$ 50 V; ±10 %; 0805; X7R; lead free		
C12	capacitor; MLCC; not connected; 47 nF; 50 V; ±10 %; 0805; X7R; RoHS compliant		
C13	capacitor; MLCC; 0.1 $\mu F;$ 50 V; ± 10 %; 0805; X7R; RoHS compliant		
C14	capacitor; MLCC; 1 nF; 50 V; \pm 10 %; 0603; X7R; RoHS compliant		
C15	capacitor; MLCC; 10 nF; 50 V; \pm 10 %; 0805; X7R; RoHS compliant		
C16	capacitor; electrolytic; KY/NCC; 10 $\mu F;$ 50 V; 105 °C; ±20 %; 5 mm \times 11.5 mm;		
C17	capacitor; MLCC; not connected; 220 pF; 100 V; 0805; NPO; RoHS compliant		
C18	capacitor; MLCC; 47 nF; 50 V; ± 10 %; 0805; NPO; lead free		
C19	capacitor; MLCC; 100 pF; 50 V; \pm 10 %; 0805; X7R; RoHS compliant		

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

Table 18. TEA1836DB1094 bill of material ...continued

Reference	Description and values	Part number	Manufacturer
CX1	X2-capacitor; MKP/R46; 0.33 μF; 275 V (AC); 105 °C;	-	Arcotronics
	18 mm × 8.5 mm × 14.5 mm; R46		
CY1	Y2-capacitor; 220 pF; 400 V (AC)	-	Murata
D2; D4	single diode; DIS; 1000 V (RMS)	1N4007,DIP/DO41	-
D3	single diode; DIS; 200 V (RMS)	BAS21H,SMT/SOD123F	NXP Semiconductors
D5	single diode; DIS; 1000 V (RMS)	SA2M,SMT/SMA	Vishay
D6	single diode; DIS; 100 V (RMS)	BAS316,SMT/SOD323	NXP Semiconductors
D7	single diode; DIS; 1000 V (RMS); current = 1 A; trr = 1.8 μ s	S1ML	Taiwan Semiconductor
F1	fuse; DIP; 3.15 AT; 250 V; 8.35 mm × 4.3 mm × 7.7 mm; MST		
INLET1	inlet	S3P,TU-333-BZ-315-P3D	Texc-Unions
L1	resistor; 0 Ω; 5 %; 0.25 W; 0805	-	-
LF1	CM choke; T12*6*4 (380 μH) 0.6φ9.5T:9.5T	-	-
LF2	CM choke; T16*12*8(16.5 mH) 0.6φ 60T:60T	-	-
Q1	n-channel MOSFET; R _{DSon} =0 .62 Ω ; V _{gs(on)} =4V ; I _d =1 0A ; C _{iss} = 1350 pF; V _{ds} = 600 V; Vgs = ± 30 V	TK10A60D,SMT/TO220	Toshiba
Q2	n-channel MOSFET; R_{DSon} =5 .4 mΩ; $V_{gs(on)}$ =3V ; I_d =1 00 A; C_{iss} =6 686p F; V_{ds} = 100 V; Vgs = ±20 V	PSMN7R0-100P,DIP/TO220	NXP Semiconductors
R1; R23	resistor; 50 kΩ; 1 %; 0.25 W; 1206	-	-
R2	resistor; not connected; 47 Ω ; 5 %; 1/8 W; 0805	-	
R3; R4	resistor; 43 kΩ; 5 %; 0.25 W; 1206	-	-
R5	resistor; 43 kΩ; 1 %; 1/8 W; 0805	-	-
R6	resistor; 470 Ω; 5 %; 1/8 W; 0805	-	-
R7	resistor; 6.8 kΩ; 1 %; 1/8 W; 0805	-	-
₹8	resistor; 4.7 Ω; 5% ; 1/8W ; 0805	-	-
R9	resistor; 10 Ω; 5 %; 1/8 W; 0805	-	-
R10	resistor; 1 kΩ; 1% ; 1/8W ; 0805	-	-
R11	resistor; not connected; 1 k Ω ; 5 %; 1/8 W; 0805		
R12	resistor; not connected; 470 $\Omega;$ 5% ; 1/8W ; 0805		
R13	resistor; 20 kΩ; 1 %; 1/8 W; 0805	-	-
R14	resistor; 165 kΩ; 1 %; 1/8 W; 0805	-	-
R15	resistor; 2.2 kΩ; 1 %; 1/8 W; 0805	-	-
R16	resistor; DIP; 0.15 Ω ; 1 %; 1 W; arial lead; MOF		
R17	resistor; 10 kΩ; 5 %; 1/8 W; 0805	-	-
R18	resistor; not connected; 47 $\Omega;$ 5 %; 1/8 W; 0805		

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

Table 18. TEA1836DB1094 bill of material ... continued

R19 resistor; 24 kΩ; 1 %; 1/8 W; 0805 - - R20 resistor; 10 Ω; 5 %; 1/8 W; 0805 - - R21 resistor; 1 kΩ; 5 %; 1/8 W; 0805 (modified connection) - - R24 resistor; 130 kΩ; 1 %; 0.25 W; 1206 - - R25 resistor; <tbd> Ω; 1 %; 1/8 W; 0805 - - RJ1; RJ4; resistor; 0 Ω; 5 %; 0.25 W; 1206 - -</tbd>	
R21 resistor; 1 k Ω ; 5 %; 1/8 W; 0805 (modified connection) - - R24 resistor; 130 k Ω ; 1 %; 0.25 W; 1206 - - R25 resistor; <tbd> Ω; 1 %; 1/8 W; 0805 - - RJ1; RJ4; resistor; 0 Ω; 5 %; 0.25 W; 1206 - -</tbd>	
connection) R24 resistor; 130 k Ω ; 1 %; 0.25 W; 1206 - - R25 resistor; <tbd> Ω; 1 %; 1/8 W; 0805 - - RJ1; RJ4; resistor; 0 Ω; 5 %; 0.25 W; 1206 - -</tbd>	
R25 resistor; $\langle \text{tbd} \rangle \Omega$; 1 %; 1/8 W; 0805	
RJ1; RJ4; resistor; 0 Ω; 5 %; 0.25 W; 1206 -	
RJ7	
RJ3; RJ5; resistor; not connected; 0 Ω ; 0.25 W; 1206 - RJ6; R22	
RT1 - TTC03A104F4192 -	
T1 transformer; flyback; RM10 -	
U1 QR flyback controller IC TEA18361T/SO14 NXP Semicon	ductors
U2 IC Shunt regulator; AS431I,SMT/SOT23R BCD adjustable precision shunt regulators	
U3 DIS,SR,TEA1792TS TEA1792TS NXP Semicon	ductors
U5 Photocoupler; 4-pins SOP; LTV-356TB LiteOn CTR = 130 %~ 260 %; 1 channel	
VOUT1 cable, 2.5 mm \times 5.5 mm \times 12 mm (kk,fk), 16AWG/1571 - L = 1200 mm	
ZD1 zener diode BZX84J-B8V2 -	
ZD2 zener diode; not connected BZX84J-B32 -	

9. T ransformer data

9.1 Introduction

For this demo board, requirements were set to show high performance in a standard 65 W form factor board using a basic circuit configuration. To reach this goal, the transformer design requires extra attention to support the combination of high-efficiency performance while still being EMI compliant using a 220 pF Y-capacitor. At the same time the concept must deliver 65 W nominal output power and generate a peak output power that is 50 % higher.

An RM10 core was used in combination with a customized bobbin type to build the transformer.

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

9.2 T ransformer data

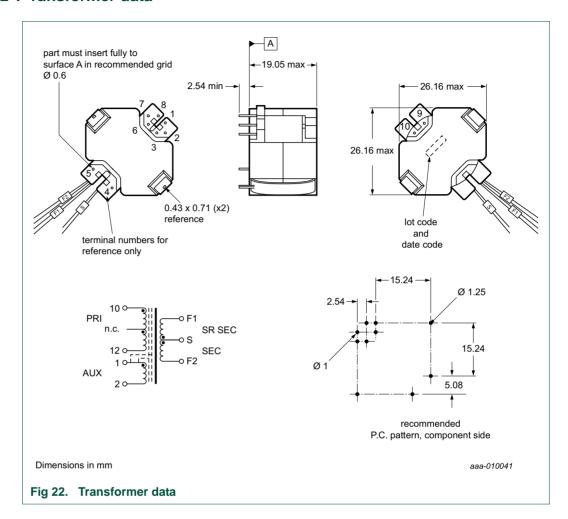


Table 19. Transformer electrical specifications at 25 °C unless otherwise noted

Feature	Value	Comment
DC resistance (at	1 to 2: 0.440 Ω ; ± 10 %	
20 °C)	10 to 12: 0.282 Ω; ±10 %	
	S to F1: 0.178 Ω; ±10 %	
	S to F2: 0.033 Ω; ±20 %	
dielectric rating	3000 V (AC)	tested 1 minute by applying 3750 V (AC) for 1 s between pins 1 and S (tie 2 + 10)
	500 V (AC)	tested 1 minute by applying 625 V (AC) for 1 s between pins 1 and 12
inductance	$340~\mu H; \pm 3~\%; 10~kHz; 100~mV$ (AC); $0~mA$ (DC); $10~to 12; L_s$	
saturation current	5 A	saturating current that causes 20 % rolloff from initial inductance

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

Table 19. Transformer electrical specifications at 25 °C unless otherwise noted ...continued

Feature	Value	Comment
leakage inductance	7.5 μ H (maximum); 100 kHz; 100 mV (AC)	10 to 12 (tie 1 + 2, $S + F1 + F 2$); L_s
turns ratio	(10 to 12): (1 to 2), (6.29): (1.00), ±1%	
	(10 to 12) : (S to F1), (3.67) : (1.00); ±1%	
	(10 to 12) : (S to F2), (5 to 5) : (1.00); $\pm 1\%$	

9.3 Transformer winding construction



TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

10. Abbreviations

Table 20. Abbreviations

Acronym	Description
BCM	Boundary Conduction Mode
DCM	Discontinuous Conduction Mode
EMI	ElectroMagnetic Interference
MOSFET	Metal-Oxide Semiconductor Field-Effect Transistor
OCP	OverCurrent Protection
OPP	OverPower Protection
OVP	OverVoltage Protection
OLP	Open-Loop Protection
PCB	Printed-Circuit Board
QR	Quasi Resonant
RMS	Root Mean Square
SOI	Silicon-On-Insulator
SR	Synchronous Rectification

11. References

- [1] TEA18361LT Data sheet GreenChip SMPS control IC
- [2] TEA18361T Data sheet GreenChip SMPS control IC
- [3] TEA18362LT Data sheet GreenChip SMPS control IC
- [4] TEA18362T Data sheet GreenChip SMPS control IC
- [5] TEA18363LT Data sheet GreenChip SMPS control IC
- [6] TEA18363T Data sheet GreenChip SMPS control IC
- [7] AN11403 Application note TEA1836X
- [8] TEA1792TS Data sheet GreenChip synchronous rectifier controller
- [9] AN11149 Application note TEA1792 GreenChip synchronous rectifier controller

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

12. Legal information

12.1 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

12.2 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Evaluation products — This product is provided on an "as is" and "with all faults" basis for evaluation purposes only. NXP Semiconductors, its affiliates and their suppliers expressly disclaim all warranties, whether express, implied or statutory, including but not limited to the implied warranties of non-infringement, merchantability and fitness for a particular purpose. The entire risk as to the quality, or arising out of the use or performance, of this product remains with customer.

In no event shall NXP Semiconductors, its affiliates or their suppliers be liable to customer for any special, indirect, consequential, punitive or incidental damages (including without limitation damages for loss of business, business interruption, loss of use, loss of data or information, and the like) arising out the use of or inability to use the product, whether or not based on tort (including negligence), strict liability, breach of contract, breach of warranty or any other theory, even if advised of the possibility of such damages.

Notwithstanding any damages that customer might incur for any reason whatsoever (including without limitation, all damages referenced above and all direct or general damages), the entire liability of NXP Semiconductors, its affiliates and their suppliers and customer's exclusive remedy for all of the foregoing shall be limited to actual damages incurred by customer based on reasonable reliance up to the greater of the amount actually paid by customer for the product or five dollars (US\$5.00). The foregoing limitations, exclusions and disclaimers shall apply to the maximum extent permitted by applicable law, even if any remedy fails of its essential purpose.

Safety of high-voltage evaluation products — The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire. This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel that is qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits.

The product does not comply with IEC 60950 based national or regional safety standards. NXP Semiconductors does not accept any liability for damages incurred due to inappropriate use of this product or related to non-insulated high voltages. Any use of this product is at customer's own risk and liability. The customer shall fully indemnify and hold harmless NXP Semiconductors from any liability, damages and claims resulting from the use of the product.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

12.3 T rademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

GreenChip — is a trademark of NXP B.V.

TEA1836DB1094 TEA1836 + TEA1792 65 W notebook adapter

13. Contents

1	Introduction	3
1.1	Scope of this document	. 3
1.2	TEA1836XT	3
1.3	TEA1792TS	
1.4	Setup of the 65 W notebook adapter	4
2	Safety warning	4
3	Board photographs	5
4	Specifications	. 6
5	Measurements	. 6
5.1	Test facilities	6
5.2	Efficiency	
5.3	Standby power consumption	
5.4	Current for changing between normal	
	and burst mode operation	7
5.5	Load regulation	7
5.6	Line regulation	
5.7	Output voltage regulation in standby mode .	
5.8	OverPower Protection (OPP)	
5.9	Voltage on pin VCC	
5.10	Brownout and start-up level	
5.11	Short circuit protection	
5.12	Overvoltage protection	
5.13	Start-up time	
5.14	Start-up profile	
5.15	Hold-up time	
5.16	Fast latch reset	
5.17	X-capacitor discharge time	
5.18	Dynamic load	
5.19	Output ripple	
5.20	EMI performance	
6	Schematic	
7	PCB layout	
8	Bill Of Material (BOM)	
9	Transformer data	
9.1	Introduction	
9.2	Transformer data	
9.3	Transformer winding construction	
10	Abbreviations	. 26
11	References	. 26
12	Legal information	. 27
12.1	Definitions	. 27
12.2	Disclaimers	. 27
12.3	Trademarks	. 27
13	Contents	. 28

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2013.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 4 December 2013

Document identifier: UM10758